

FDP42AN15A0 / FDB42AN15A0

N-Channel PowerTrench[®] MOSFET 150V, 35A, 42mΩ

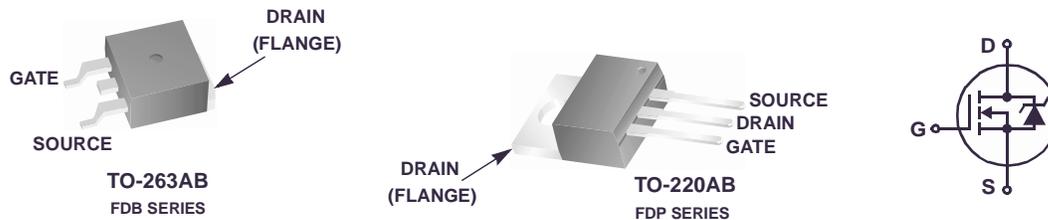
Features

- $r_{DS(ON)} = 36m\Omega$ (Typ.), $V_{GS} = 10V$, $I_D = 12A$
- $Q_g(tot) = 33nC$ (Typ.), $V_{GS} = 10V$
- Low Miller Charge
- Low Q_{rr} Body Diode
- UIS Capability (Single Pulse and Repetitive Pulse)
- Qualified to AEC Q101

Formerly developmental type 82864

Applications

- DC/DC Converters and Off-line UPS
- Distributed Power Architectures and VRMs
- Primary Switch for 24V and 48V Systems
- High Voltage Synchronous Rectifier
- Direct Injection / Diesel Injection Systems
- 42V Automotive Load Control
- Electronic Valve Train Systems



MOSFET Maximum Ratings $T_C = 25^\circ\text{C}$ unless otherwise noted

| Symbol | Parameter | Ratings | Units |
|----------------|--|------------|--------------------|
| V_{DSS} | Drain to Source Voltage | 150 | V |
| V_{GS} | Gate to Source Voltage | ± 20 | V |
| I_D | Drain Current | | |
| | Continuous ($T_C = 25^\circ\text{C}$, $V_{GS} = 10V$) | 35 | A |
| | Continuous ($T_C = 100^\circ\text{C}$, $V_{GS} = 10V$) | 24 | |
| | Continuous ($T_{amb} = 25^\circ\text{C}$, $V_{GS} = 10V$, with $R_{\theta JA} = 43^\circ\text{C/W}$) | 5 | A |
| | Pulsed | Figure 4 | A |
| E_{AS} | Single Pulse Avalanche Energy (Note 1) | 90 | mJ |
| P_D | Power dissipation | 150 | W |
| | Derate above 25°C | 1.00 | $W/^\circ\text{C}$ |
| T_J, T_{STG} | Operating and Storage Temperature | -55 to 175 | $^\circ\text{C}$ |

Thermal Characteristics

| | | | |
|-----------------|---|-----|--------------------|
| $R_{\theta JC}$ | Thermal Resistance Junction to Case TO-220, TO-263 | 1.0 | $^\circ\text{C/W}$ |
| $R_{\theta JA}$ | Thermal Resistance Junction to Ambient TO-220, TO-263 | 62 | $^\circ\text{C/W}$ |
| $R_{\theta JA}$ | Thermal Resistance Junction to Ambient TO-263, 1in ² copper pad area | 43 | $^\circ\text{C/W}$ |

Package Marking and Ordering Information

| Device Marking | Device | Package | Reel Size | Tape Width | Quantity |
|----------------|-------------|----------|-----------|------------|-----------|
| FDB42AN15A0 | FDB42AN15A0 | TO-263AB | 330mm | 24mm | 800 units |
| FDP42AN15A0 | FDP42AN15A0 | TO-220AB | Tube | N/A | 50 units |

Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted

| Symbol | Parameter | Test Conditions | Min | Typ | Max | Units |
|--------|-----------|-----------------|-----|-----|-----|-------|
|--------|-----------|-----------------|-----|-----|-----|-------|

Off Characteristics

| | | | | | | |
|------------|-----------------------------------|--|-----|---|-----------|---------------|
| B_{VDSS} | Drain to Source Breakdown Voltage | $I_D = 250\mu\text{A}, V_{GS} = 0\text{V}$ | 150 | - | - | V |
| I_{DSS} | Zero Gate Voltage Drain Current | $V_{DS} = 120\text{V}$ | - | - | 1 | μA |
| | | $V_{GS} = 0\text{V}$ $T_C = 150^\circ\text{C}$ | - | - | 250 | |
| I_{GSS} | Gate to Source Leakage Current | $V_{GS} = \pm 20\text{V}$ | - | - | ± 100 | nA |

On Characteristics

| | | | | | | |
|--------------|----------------------------------|--|---|-------|-------|----------|
| $V_{GS(TH)}$ | Gate to Source Threshold Voltage | $V_{GS} = V_{DS}, I_D = 250\mu\text{A}$ | 2 | - | 4 | V |
| $r_{DS(ON)}$ | Drain to Source On Resistance | $I_D = 12\text{A}, V_{GS} = 10\text{V}$ | - | 0.036 | 0.042 | Ω |
| | | $I_D = 6\text{A}, V_{GS} = 6\text{V}$ | - | 0.040 | 0.060 | |
| | | $I_D = 12\text{A}, V_{GS} = 10\text{V}, T_J = 175^\circ\text{C}$ | - | 0.090 | 0.107 | |

Dynamic Characteristics

| | | | | | | |
|--------------|----------------------------------|---|---|------|-----|----|
| C_{ISS} | Input Capacitance | $V_{DS} = 25\text{V}, V_{GS} = 0\text{V}, f = 1\text{MHz}$ | - | 2150 | - | pF |
| C_{OSS} | Output Capacitance | | - | 225 | - | pF |
| C_{RSS} | Reverse Transfer Capacitance | | - | 45 | - | pF |
| $Q_{g(TOT)}$ | Total Gate Charge at 10V | $V_{GS} = 0\text{V to } 10\text{V}$ | - | 30 | 39 | nC |
| $Q_{g(TH)}$ | Threshold Gate Charge | $V_{GS} = 0\text{V to } 2\text{V}$ | - | 4.2 | 5.4 | nC |
| Q_{gs} | Gate to Source Gate Charge | $V_{DD} = 75\text{V}$ $I_D = 12\text{A}$ $I_g = 1.0\text{mA}$ | - | 9.5 | - | nC |
| Q_{gs2} | Gate Charge Threshold to Plateau | | - | 5.3 | - | nC |
| Q_{gd} | Gate to Drain "Miller" Charge | | - | 6.9 | - | nC |

Switching Characteristics ($V_{GS} = 10\text{V}$)

| | | | | | | |
|--------------|---------------------|--|---|----|----|----|
| t_{ON} | Turn-On Time | $V_{DD} = 75\text{V}, I_D = 12\text{A}$ $V_{GS} = 10\text{V}, R_{GS} = 7.5\Omega$ | - | - | 46 | ns |
| $t_{d(ON)}$ | Turn-On Delay Time | | - | 11 | - | ns |
| t_r | Rise Time | | - | 19 | - | ns |
| $t_{d(OFF)}$ | Turn-Off Delay Time | | - | 27 | - | ns |
| t_f | Fall Time | | - | 23 | - | ns |
| t_{OFF} | Turn-Off Time | | - | - | 74 | ns |

Drain-Source Diode Characteristics

| | | | | | | |
|----------|-------------------------------|---|---|---|------|----|
| V_{SD} | Source to Drain Diode Voltage | $I_{SD} = 12\text{A}$ | - | - | 1.25 | V |
| | | $I_{SD} = 6\text{A}$ | - | - | 1.0 | V |
| t_{rr} | Reverse Recovery Time | $I_{SD} = 12\text{A}, dI_{SD}/dt = 100\text{A}/\mu\text{s}$ | - | - | 82 | ns |
| Q_{RR} | Reverse Recovered Charge | $I_{SD} = 12\text{A}, dI_{SD}/dt = 100\text{A}/\mu\text{s}$ | - | - | 204 | nC |

Notes:

1: Starting $T_J = 25^\circ\text{C}$, $L = 0.2\text{mH}$, $I_{AS} = 30\text{A}$.

Typical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted

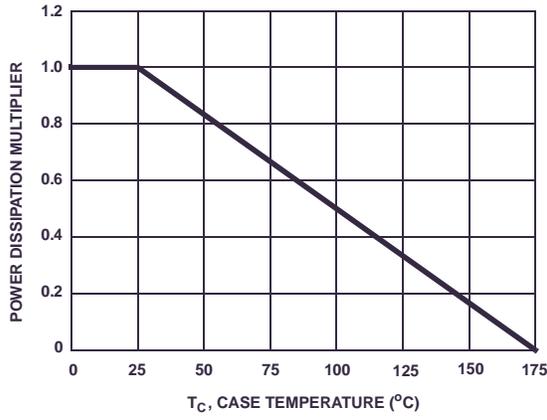


Figure 1. Normalized Power Dissipation vs Ambient Temperature

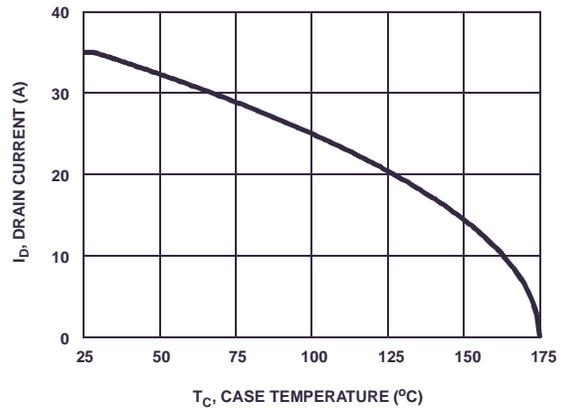


Figure 2. Maximum Continuous Drain Current vs Case Temperature

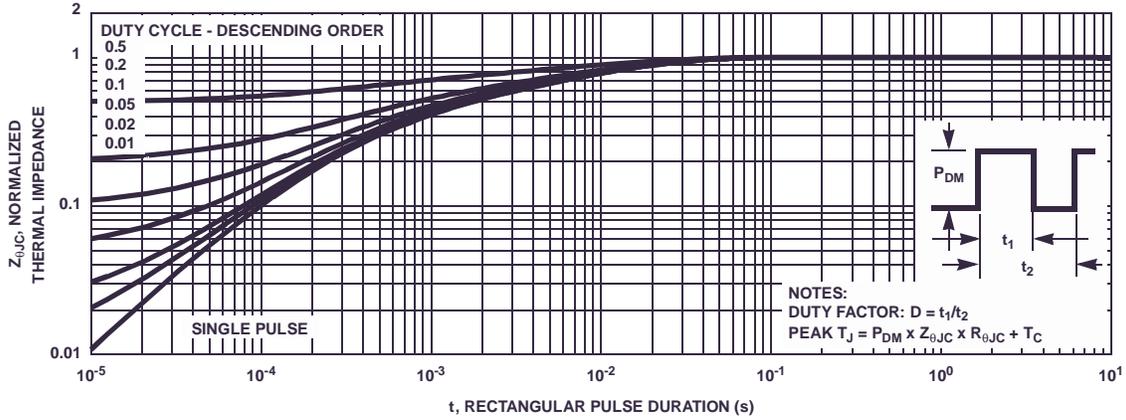


Figure 3. Normalized Maximum Transient Thermal Impedance

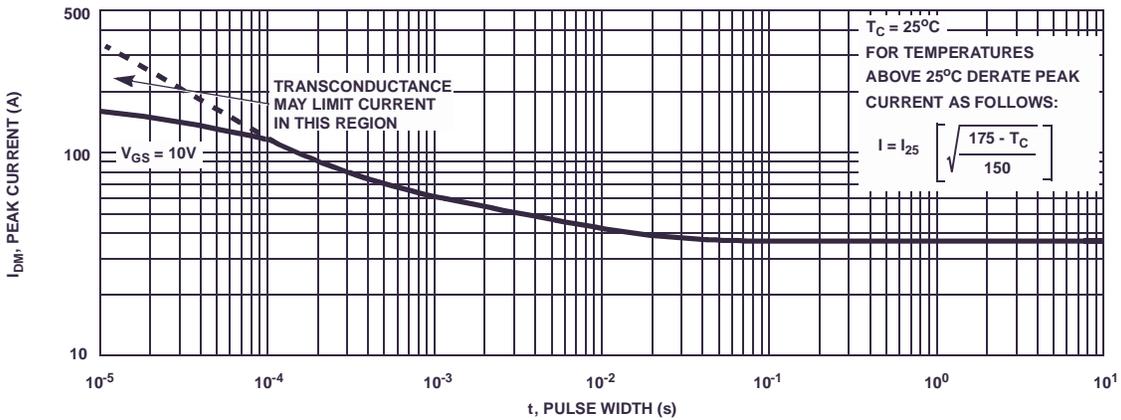


Figure 4. Peak Current Capability